

Title (en)

BATHS AND PROCESS FOR CHEMICAL POLISHING OF COPPER AND COPPER ALLOY SURFACES

Publication

EP 0425012 B1 19930414 (FR)

Application

EP 90202734 A 19901015

Priority

BE 8901150 A 19891024

Abstract (en)

[origin: US5098517A] Baths for chemical polishing of copper or copper alloy surfaces, comprising, in aqueous solution, hydrogen peroxide, phosphoric acid and tetraborate ions.

IPC 1-7

C23F 3/06

IPC 8 full level

C23F 1/18 (2006.01); **C23F 3/06** (2006.01)

CPC (source: EP KR US)

C23F 1/44 (2013.01 - KR); **C23F 3/06** (2013.01 - EP US)

Citation (examination)

Protection of Metals, vol. 25, no. 2 (mars/avril 1989), page 257; New York, US, A.I.Turashev.

Designated contracting state (EPC)

AT BE CH DE DK ES FR GB GR IT LI LU NL SE

DOCDB simple family (publication)

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